

## **STW14NM50**

# N-CHANNEL 550V @ Tjmax - 0.32Ω - 14A TO-247 MDmesh™ MOSFET

**Table 1: General Features** 

TYPE	V <sub>DSS</sub> (@Tjmax)	R <sub>DS(on)</sub>	I <sub>D</sub>
STW14NM50	550 V	< 0.35 Ω	14 A

- TYPICAL R<sub>DS</sub>(on) =  $0.32 \Omega$
- HIGH dv/dt AND AVALANCHE CAPABILITIES
- 100% AVALANCHE RATED
- LOW INPUT CAPACITANCE AND GATE CHARGE
- LOW GATE INPUT RESISTANCE
- TIGHT PROCESS CONTROL AND HIGH MANUFACTORING YIELDS

#### **DESCRIPTION**

The MDmesh™ is a new revolutionary MOSFET technology that associates the Multiple Drain process with the Company's PowerMESH™ horizontal layout. The resulting product has an outstanding low on-resistance, impressively high dv/dt and excellent avalanche characteristics. The adoption of the Company's proprierati strip technique yields overall dynamic performance that is significantly better than that of similar con pletition's products.

#### **APPLICATIONS**

The MDmesh<sup>™</sup> family is very suitablr for increase the power density of high vo tage converters allowing system miniaturization and higher efficiencies.

Figure 1: Package

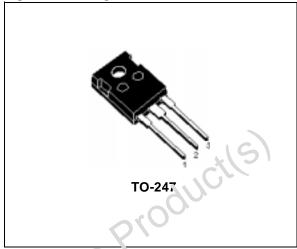


Figure 2: Into nel Schematic Diagram

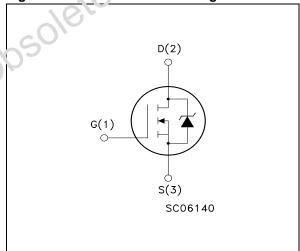


Table 2: Greer Codes

SALES TYPE	MARKING	PACKAGE	PACKAGING
STW14NM50	W14NM50	TO-247	TUBE

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**Table 3: Absolute Maximum ratings** 

Symbol	Parameter	Value	Unit
V <sub>GS</sub>	Gate- source Voltage	±30	V
I <sub>D</sub>	Drain Current (continuous) at T <sub>C</sub> = 25°C	14	Α
ID	Drain Current (continuous) at T <sub>C</sub> = 100°C	8.8	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain Current (pulsed)	56	А
P <sub>TOT</sub>	Total Dissipation at T <sub>C</sub> = 25°C	175	W
	Derating Factor	1.28	W/°C
dv/dt	Peak Diode Recovery voltage slope	6	V/ns
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

<sup>(•)</sup>Pulse width limited by safe operating area

#### **Table 4: Thermal Data**

Rthj-case	Thermal Resistance Junction-case Max	0.715	°C/W
Rthj-amb	Thermal Resistance Junction-ambient Max	30	°C/W
T <sub>I</sub>	Maximum Lead Temperature For Soldering Purpose	300	°C

### **Table 5: Avalanche Characteristics**

Symbol	Parameter	Max Value	Unit
I <sub>AR</sub>	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by T <sub>j</sub> max)	12	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	400	mJ

# **ELECTRICAL CHARACTERISTICS** (T<sub>CASE</sub> =25°C UNLESS OTHERWISE SPECIFIED)

#### Table 6: On /Off

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0$	500			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max Rating $V_{DS}$ = Max Rating, $T_{C}$ = 125°C			1 10	μΑ μΑ
I <sub>GSS</sub>	Gate-body Leakage Current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 30 V			± 100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R <sub>DS(on</sub>	Static Drain-source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A		0.32	0.35	Ω

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<sup>(\*)</sup>Limited only by maximum temperature allowed

 $<sup>(1)</sup>I_{SD} \leq 14A, \ di/dt \leq 100A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_j \leq T_{JMAX}.$ 

## **ELECTRICAL CHARACTERISTICS (CONTINUED)**

## **Table 7: Dynamic**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g <sub>fs</sub> (1)	Forward Transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_{D} = 6A$		5.2		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,} $ $V_{GS} = 0$		1000 180 25		pF pF pF
Coss eq (3).	Equivalent Output Capacitance	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 to 400 V		90		pF
R <sub>G</sub>	Gate Input Resistance	f=1 MHz Gate DC Bias = 0 Test Signal Level = 20mV Open Drain		1.6		Ω
t <sub>d(on)</sub>	Turn-on Delay Time Rise Time	$V_{DD} = 250 \text{ V}, I_D = 6 \text{ A},$		20 10		ns
t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-off-Delay Time Fall Time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see Figure 15)		19 8	IG	ns ns ns
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate Charge Gate-Source Charge Gate-Drain Charge	$V_{DD} = 400 \text{ V}, I_{D} = 12 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see Figure 18)		28 8 15	38	nC nC nC

#### **Table 8: Source Drain Diode**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub> I <sub>SDM</sub> (2)	Source-drain Current Source-drain Current (pulsed)	9/6			14 56	A A
V <sub>SD</sub> (1)	Forward On Voltage	I <sub>SD</sub> = 12 A, V <sub>GS</sub> = 0			1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 12 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 100 \text{V}$ (see Figure 16)		270 2.23 16.5		ns µC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 12 \text{ A, di/dt} = 100 \text{ A/µs}$ $V_{DD} = 100 \text{V, T}_j = 150 ^{\circ}\text{C}$ (see Figure 16)		340 3 18		ns µC A

<sup>(1)</sup> Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %.
(2) Pulse width limited by safe operating area.

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<sup>(3)</sup> Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

Figure 3: Safe Operating Area

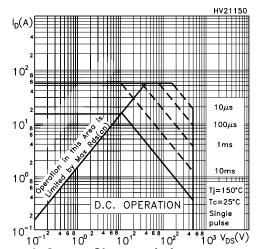


Figure 4: Output Characteristics

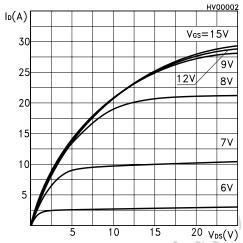


Figure 5: Transconductance

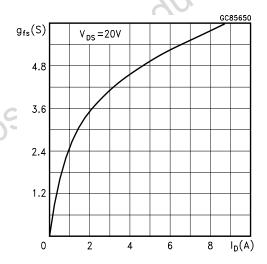
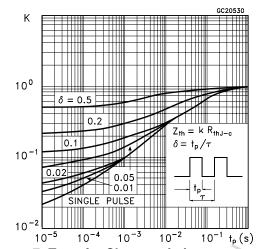


Figure 6: Thermal Impedance



**Figure 7: Transfer Characteristics** 

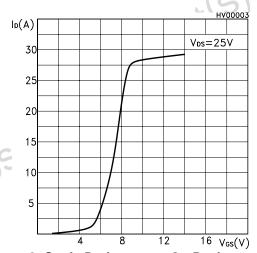
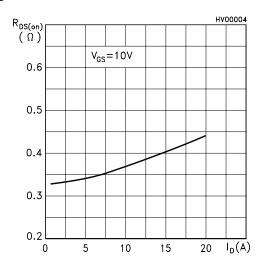


Figure 8: Static Drain-source On Resistance



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Figure 9: Gate Charge vs Gate-source Voltage

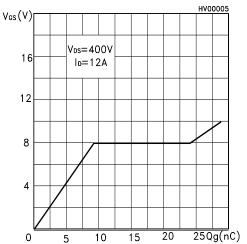


Figure 10: Normalized Gate Thereshold Voltage vs Temperature

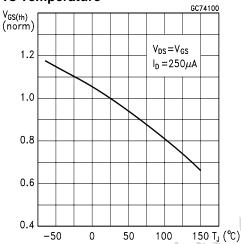


Figure 11: Dource-Drain Diode Forward Characteristics

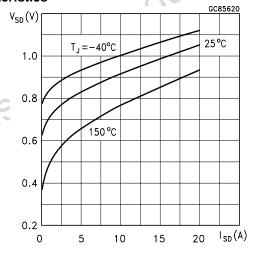


Figure 12: Capacitance Variations

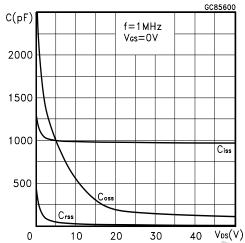


Figure 13: Normalized On Resistance vs Temperature

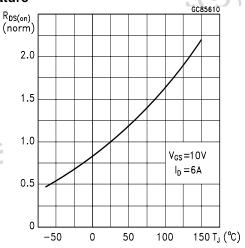


Figure 14: Unclamped Inductive Load Test Circuit

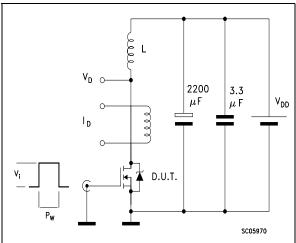
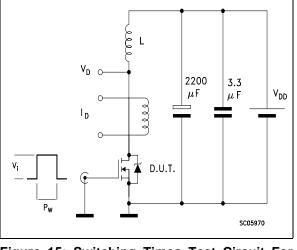


Figure 15: Switching Times Test Circuit For Resistive Load



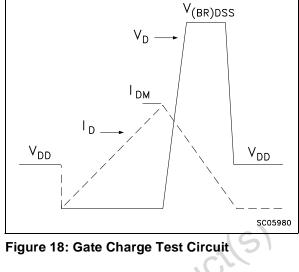


Figure 17: Unclamped Inductive Wafeform

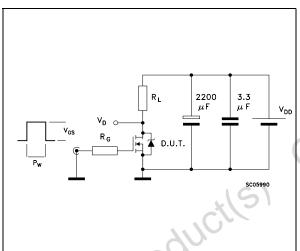
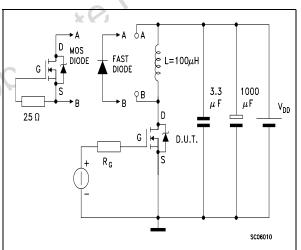
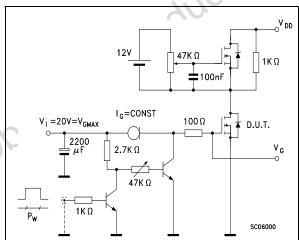


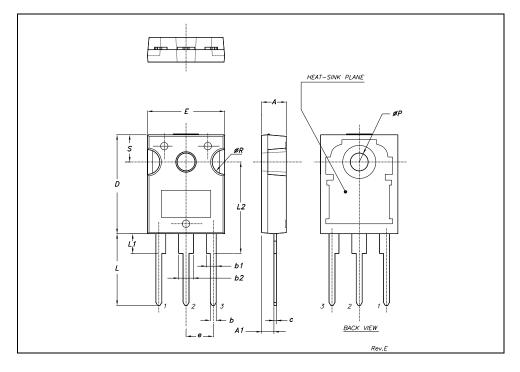
Figure 16: Test Circuit For Inductive Load Switching and Diode Recovery Times





## **TO-247 MECHANICAL DATA**

DIM.		mm.			inch	
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
Е	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	





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**Table 9: Revision History** 

Date	Revision	Description of Changes
05-July-2004	5	The document change from "PRELIMINARY" to "COMPLETE".
		New Stylesheet.



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